ABSTRACT

SUBSTRATE LOADING APPARATUS

The present invention provides apparatus for loading a substrate (65) onto a processing surface (61) in a thinfilm processing chamber (60). The apparatus includes a with cooperates/ one more support (66) which corresponding apertures (62) in the processing surface so as to be movable between an extended position in which the 10 support can support a substrate (65) above the processing surface (61), and a retracted position in which the support is flush with or located below the processing surface (61). The support has a number of limbs (64) which extend radially outwardly from a central hub, at an angle relative 15 to the processing surface. The limbs contact the edges of different sized substrates in use so as to support the substrate in a/support plane above the central hub and substantially parallel to the processing surface.

A. Germ, Joseph, Joseph, 1997,